



# **N-Channel Super Trench Power MOSFET**

## **Description**

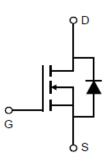
The RM185N30DF uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{\text{DS(ON)}}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

#### **General Features**

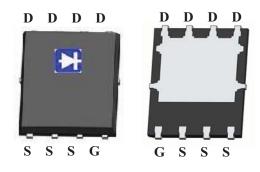
- $V_{DS}$  =30V, $I_D$  =185A  $R_{DS(ON)}$ =1.1m $\Omega$  (typical) @  $V_{GS}$ =10V  $R_{DS(ON)}$ =1.45m $\Omega$  (typical) @  $V_{GS}$ =4.5V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

#### **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



**Schematic Diagram** 



**Top View** 

**Bottom View** 

100% UIS TESTED!

100% ΔVds TESTED!

## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
185N30	RM185N30DF	DFN5X6-8L	-	-	-

## Absolute Maximum Ratings (T<sub>C</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	30	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Drain Current-Continuous (Silicon Limited)	I <sub>D</sub>	185	А
Drain Current-Continuous(T <sub>C</sub> =100°C)	I <sub>D</sub> (100℃)	140	А
Pulsed Drain Current (Package Limited)	I <sub>DM</sub>	400	А
Maximum Power Dissipation	P <sub>D</sub>	95	W
Derating factor		0.76	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	1300	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}\mathbb{C}$

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case (Note 2)	R <sub>eJC</sub>	1.32	°C/W
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Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

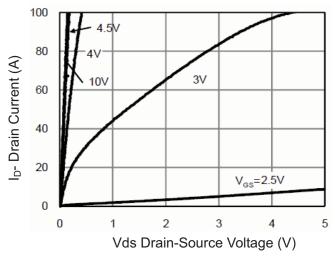
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	30		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.0	1.5	2.0	V
Dunin Course On Chata Desintance	Б	V <sub>GS</sub> =10V, I <sub>D</sub> =95A		1.1	1.4	mΩ
Prain-Source On-State Resistance  Forward Transconductance  Pynamic Characteristics (Note4)  Input Capacitance  Dutput Capacitance  Reverse Transfer Capacitance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =95A	-	1.45	1.8	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =95A	90	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	\/ -45\/\/ -0\/	-	7350	8800	PF
Output Capacitance	Coss	$V_{DS}=15V, V_{GS}=0V,$	-	1930	2300	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	110	130	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	15	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =15 $V$ , $I_{D}$ =95 $A$	-	10	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =3 $\Omega$	-	51	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	12	-	nS
Total Gate Charge	Qg	\/ -45\/ L -05A	-	125	140	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =15V, $I_{D}$ =95A, $V_{GS}$ =10V	-	18		nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> -10V	-	13		nC
Drain-Source Diode Characteristics	- 1		•			
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =95A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	185	Α
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25$ °C, $I_F = I_S$	-		38	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-		126	nC

#### Notes:

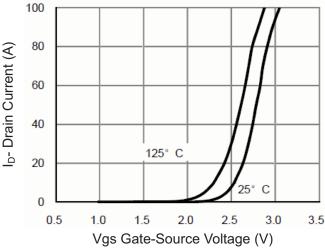
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25  $^{\circ}\text{C}$  ,VDD=50V,VG=10V,L=0.5mH,Rg=25 $\Omega$



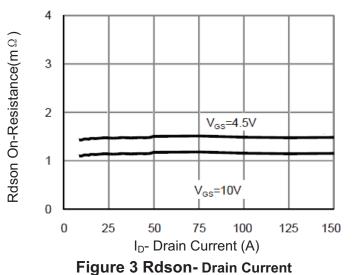
## RATING AND CHARACTERISTICS CURVES (RM185N30DF)



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 



1.6 Normalized On-Resistance  $V_{GS}=10V$ 1.4 I<sub>D</sub>=95 A 1.2  $V_{GS}=4.5V$ I<sub>D</sub>=95 A 8.0 25 0 50 75 100 125 150 175 T<sub>J</sub>-Junction Temperature(°C)

**Figure 4 Rdson-Junction Temperature** 

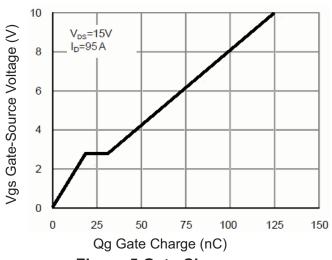


Figure 5 Gate Charge

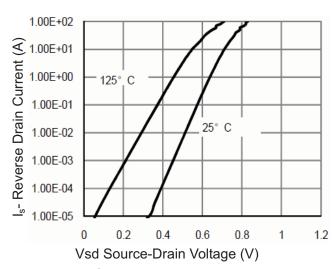


Figure 6 Source- Drain Diode Forward



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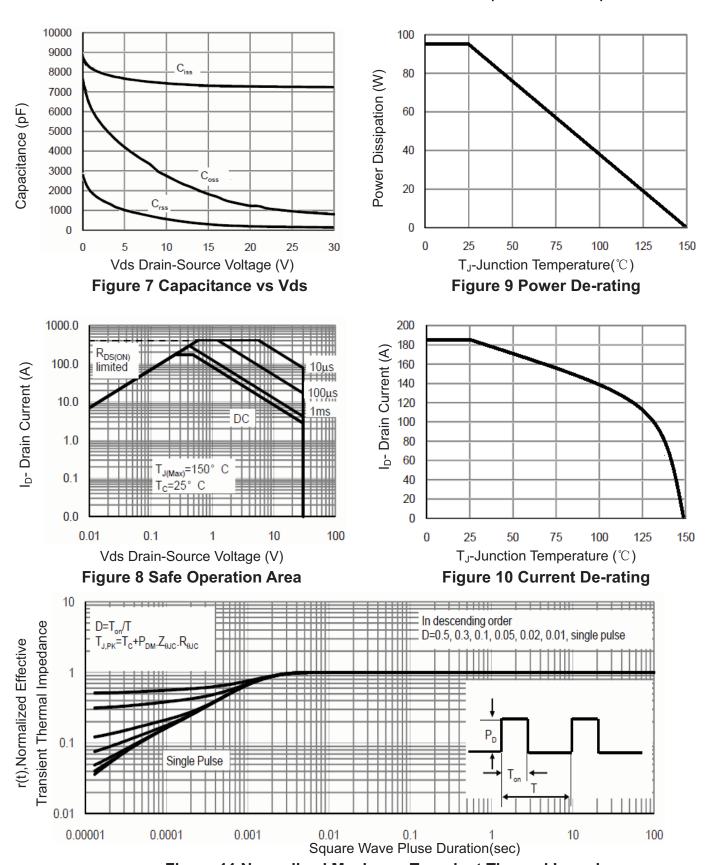
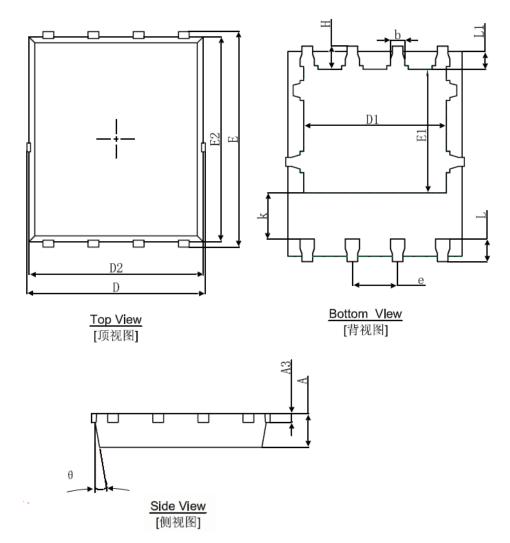


Figure 11 Normalized Maximum Transient Thermal Impedance



# **DFN5X6-8L Package Information**



C) male al	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	0.900	1.000	0.035	0.039	
A3	0.254	REF.	0.010	REF.	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
е	1.270	TYP.	0.050	OTYP.	
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Η	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	



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